

AP3171

# **Typical Applications Circuit**



Pin Number	Pin Name	Function		
1	vcc	IC voltage supplier and input voltage for power conversion; Decoupling cap is required to be placed to this pin and GND pin as close as possible		
2	CABLE	Connected to the external resistor to set the cable compensation value		
3	D+	Connected to USB D+		
4	D-	Connected to USB D-		
5	Ουτ	Sense the output voltage; connected to the input of current sense resistor		
6	VSEN	Sense the output current; connected to the output of current sense resistor		
7	СМР	The EA output pin to compensate the loop		
8	GND	Ground return for the power stage and controller		
Exposed PAD	PHASE	Connected to the input of external output inductor		



AP3171

## **Functional Block Diagram**



### Absolute Maximum Ratings (Note 4)

Parameter	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	-0.3 to 42	V
Voltage From PHASE to GND	V <sub>PHASE</sub>	-0.3 to 42	V
Voltage From OUT to GND	Vout	-0.3 to 20	V
Voltage on Other Separate Pins	-	-0.3 to 6	V
Thermal Resistance (Note 5)	θја	63	°C/W
Operating Junction Temperature	TJ	-40 to +125	°C
Storage Temperature	T <sub>STG</sub>	-65 to +150	°C
ESD (Human Body Model)	-	2000	V
ESD (Machine Model)	-	200	V

 Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1 square inch pad layout. Note:



## **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	10	40	V
T <sub>A</sub>	Ambient Temperature	-40	+85	°C

Electrical Characteristics	(@ $T_A = +25^{\circ}C$ , $V_{CC} = 16V$ , unless otherwise specified.)
----------------------------	---

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Supply Voltage								
V <sub>ST</sub>	Startup Voltage	-	8.4	8.7	9.0	V		
_	UVLO	_	6.75	7.00	7.25	V		
I <sub>NO-LOAD</sub>	ICC @ No-load Condition	-		2		mA		
CV/CC Control								
V <sub>REF_12V</sub>		-	11.7	12.0	12.3	V		
V <sub>REF_9V</sub>	Voltage Control Loop Reference	-	8.77	9.00	9.23	V		
V <sub>REF_5V</sub>		-	4.92	5.00	5.08	V		
V <sub>CABLE</sub>	Cable Compensation	$R_{CABLE} = 17.6k,$ $R_{SENSE} = 27.27m\Omega$		400	-	mV		
V <sub>CS_12V</sub>		-	41.0	45.0	49.0	mV		
V <sub>CS_9V</sub>	Current Control Loop Reference	-	57.0	60.0	63.0	mV		
V <sub>CS_5V</sub>		-	57.6	60.0	62.4	mV		
Internal MOSFET					•			
R <sub>DS(ON)_UP</sub>	High Side MOSFET RDS(ON)		<b>-</b>	100	-	mΩ		
R <sub>DS(ON)</sub> LOW	Low Side MOSFET RDS(ON)	-	-	45	-	mΩ		
PWM And Oscilla	tion							
fs	Switching Frequency	-	-	120	-	kHz		
D <sub>MAX</sub>	Maximum Duty		-	95	-	%		
I <sub>DIS</sub>	Discharge Current@ OUT Pin	-	_	100	_	mA		
Protection	Protection							
V <sub>OVP_5V</sub>	Output OVP Threshold @5V		5.63	5.80	5.97	V		
Vovp_9v	Output OVP Threshold @9V	Note 6	10.13	10.44	10.75	V		
VOVP_12V	Output OVP Threshold @12V		13.51	13.92	14.33	V		
VUVP_5V	Output UVP Threshold @5V	-	3.13	3.30	3.47	V		
Vuvp_9v	Output UVP Threshold @9V	-	5.63	5.94	6.24	V		
VUVP_12V	Output UVP Threshold @12V	-	7.51	7.92	8.33	V		
IPK_MAX	MOSFET Maximum IPEAK Limitation	-	_	4.0	_	А		
Internal OTP								
-	Internal OTP Trigger Temperature	-	-	+160	-	°C		
-	Internal OTP Recovery Temperature	-	-	+140	-	°C		
QC 2.0 protocol d	lefinition							
VDAT_REF	Data Detect Voltage	-	0.25	0.325	0.40	V		
V <sub>SEL_REF</sub>	VSEL_REF (Reference for Selecting HVDCP Voltage)	_	1.8	2	2.2	V		
tGLITCH_BC_DONE	D+ High Glitch Filter Time	-	1	1.25	1.5	S		
tGLITCH_DM_LOW	D- Low Glitch Filter Time	Note 7	1	2.5	-	ms		

Notes: 6. The value in table is only for  $I_0=0A$ . If  $I_0$  is not zero, the over voltage protection value needs to add cable compensation voltage. 7. Guaranteed by design.



### **Operation Description**

#### Qualcomm QC 2.0 Protocol Operation

Decoder	<b>V</b> <sub>D+</sub> (∨)	$V_{D-}(\vee)$	Charger Output Voltage/Full Current Capability
Qualcomm Quick Charge	0.6	0.6	12V/1.5A
	3.3	0.6	9V/2A
2.0 Protocol	0.6	3.3	Keep Present V1/V2 Status Unchanged
Class A: 5V, 9V, 12V	3.3	3.3	Keep Present V1/V2 Status Unchanged
	0.6 or 3.3	GND	5V/2A
	GND	0.6 or 3.3 or GND	5V/2A (Protocol Handshake Reset)

#### **Constant Current Operation**

The AP3171 can work in constant-current (CC) mode. The output current is sensed by a current sense resistor  $R_{SENSE}$ . As output current increases, the voltage drop across  $R_{SENSE}$  will be limited to a reference voltage (V<sub>CS</sub>) to accomplish CC function. The default  $R_{SENSE}$  is 27.27m $\Omega$  to get the typical CC point of 110% full output current.

#### **Cable Compensation**

The cable compensation can be calculated as below:  $V_{CABLE}{=}I_{O}^{*}$  R\_{SENSE} \*129.5k/R\_{CABLE}

# **Ordering Information**

Product Name	AP3171 XX Package MP: SO-8EP	XX - XX Packing TR : Tape & Reel	RoHS/Green G1 : Green	
Package	Part Number	Marking ID	Packing	
SO-8EP	AP3171MPTR-G1	3171MP-G1	4,000/Tape & Reel	
arking Information				
(Тор View) <u>Н Н Н Н</u>	First and Second Lines: I Third Line: Date Code Y: Year WW: Work Week of Mole A: Assembly House Cod XX: 7 <sup>th</sup> and 8 <sup>th</sup> Digits of E	Logo and Marking ID ding e 3atch No.		



### Package Outline Dimensions (All dimensions in mm(inch).)





# **Suggested Pad Layout**



Dimensions	Z	G	X	Y	X1	Y1	E
	(mm)/(inch)						
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	3.600/0.142	2.700/0.106	1.270/0.050



#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2020, Diodes Incorporated

www.diodes.com